

MOS FIELD EFFECT TRANSISTOR 2SK3366

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK3366 is N-Channel MOS Field Effect Transistor designed for DC/DC converter application of notebook computers.

FEATURES

· Low on-resistance

$$\begin{split} &R_{DS(on)1}=21~m\Omega~(MAX.)~(V_{GS}=10~V,~I_{D}=10~A)\\ &R_{DS(on)2}=33~m\Omega~(MAX.)~(V_{GS}=4.5~V,~I_{D}=10~A) \end{split}$$

 $R_{DS(on)3} = 43 \text{ m}\Omega \text{ (MAX.) (Vgs} = 4.0 \text{ V, Ip} = 10 \text{ A)}$

• Low Ciss : Ciss = 730 pF (TYP.)

· Built-in gate protection diode

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3366	TO-251
2SK3366-Z	TO-252

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (Vss = 0 V)	VDSS	30	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±20	V
Drain Current (DC)	I _{D(DC)}	±20	Α
Drain Current (Pulse) Note	ID(pulse)	±80	Α
Total Power Dissipation (Tc = 25 °C)	PT	30	W
Total Power Dissipation (T _A = 25 °C)	PT	1.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tsta	-55 to + 150	°C

Note PW \leq 10 μ s, Duty cycle \leq 1 %

THERMAL RESISTANCE

Channel to case	Rth(ch-C)	4.17	°C/W
Channel to ambient	Rth(ch-A)	125	°C/W

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

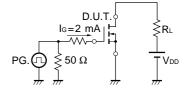


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 10 A		17.2	21	mΩ
	R _{DS(on)2}	V _G S = 4.5 V, I _D = 10 A		26	33	mΩ
	R _{DS(on)3}	Vgs = 4.0 V, Ip = 10 A		33	43	mΩ
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 10 A	5	10		S
Drain Leakage Current	Ipss	Vps = 30 V, Vgs = 0 V			10	μΑ
Gate to Source Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Input Capacitance	Ciss	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		730		pF
Output Capacitance	Coss			250		pF
Reverse Transfer Capacitance	Crss			120		pF
Turn-on Delay Time	td(on)	$I_D = 10 \text{ A}, V_{GS(on)} = 10 \text{ V}, V_{DD} = 15 \text{ V},$		28		ns
Rise Time	tr	$R_G = 10 \Omega$		420		ns
Turn-off Delay Time	t _{d(off)}			47		ns
Fall Time	tf			64		ns
Total Gate Charge	QG	ID = 20 A, VDD = 24 V, VGS = 10 V		15		nC
Gate to Source Charge	Qgs			2.8		nC
Gate to Drain Charge	Q _{GD}			4.1		nC
Body Diode forward Voltage	V _F (S-D)	IF = 20 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 20 A, VGS = 0 V		30		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		26		nC

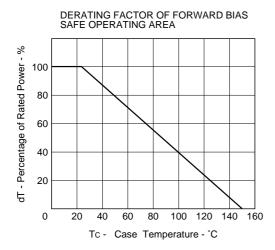
TEST CIRCUIT 1 SWITCHING TIME

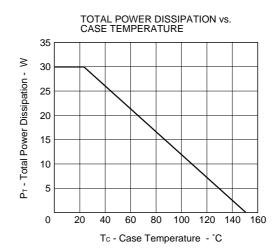
TEST CIRCUIT 2 GATE CHARGE



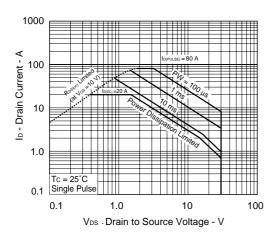


TYPICAL CHARACTERISTICS (TA = 25 °C)

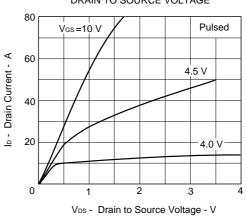




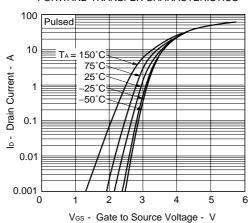
★ FORWARD BIAS SAFE OPERATING AREA





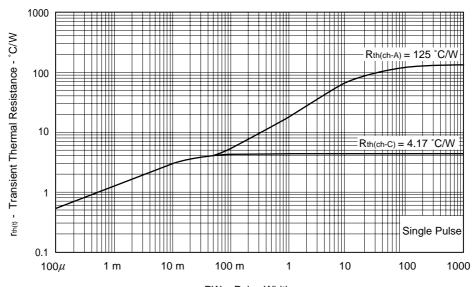


FORWARD TRANSFER CHARACTERISTICS



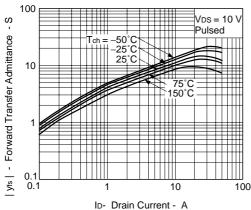
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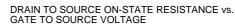
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

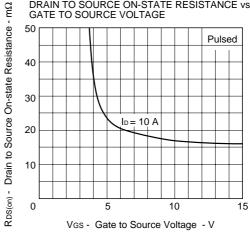


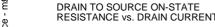
PW - Pulse Width - s

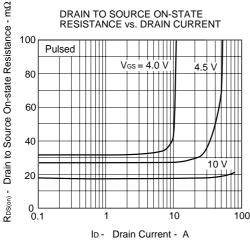


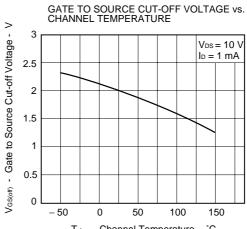






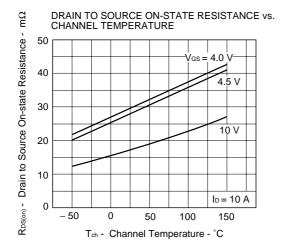


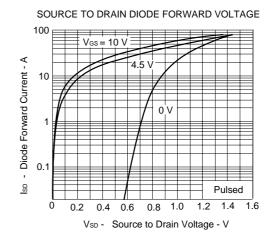


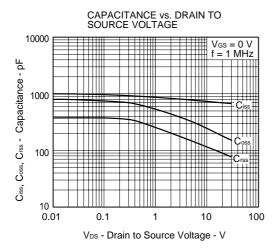


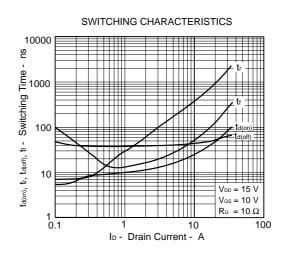
Tch - Channel Temperature - °C

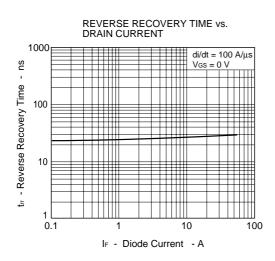


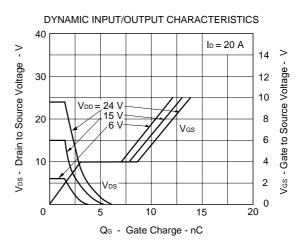










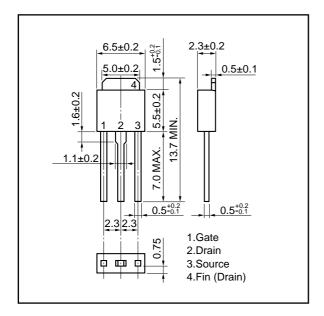


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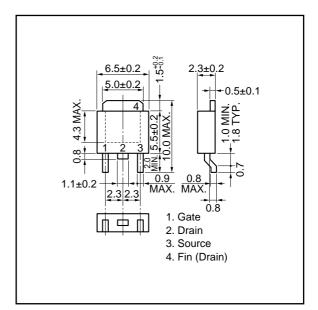


PACKAGE DRAWINGS (Unit: mm)

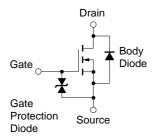
1) TO-251 (MP-3)



2) TO-252 (MP-3Z)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

[MEMO]

[MEMO]

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